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IEEE ICME 2007 Call for Papers 2007 International Conference on Multimedia (ICME)

July 2-5, 2007, Crown Plaza Hotel, Beijing, China









Sponsored by: Circuits and Systems Society, Communications Society, Computer Society, and Signal Processing Society

IEEE International Conference on Multimedia is a major annual international conference organized with the objective of brining together researchers, developers, and practitioners from academia and industry working in all areas in multimedia. ICME serves as a forum for the dissemination of state-of-the-art research, development, and implementations of multimedia systems, technologies and applications. ICME is co-sponsored by four IEEE societies (the Computer Society, the Signal Processing Society, the Circuits and Systems Society, and the Communications Society).

Authors should submit a four-page manuscript in double-column format including authors' names, affiliations, and a short abstract. Only electronic submissions will be accepted. Topics include but not limited to:

- · Audio, image, video processing
- · Virtual reality and 3-D imaging
- Signal processing for media integration
- Multimedia Communications and networking
- · Multimedia security and content protection
- Multimedia human-machine interface and interaction
- Multimedia databases
- Multimedia computing systems and appliances
- Hardware and software for multimedia systems
- Multimedia standards and related issues
- Multimedia applications

A number of awards will be presented to the Best Papers/Best Student Papers at the conference. In addition to traditional technical programs, we will hold workshops in conjunction with the main conference. Please check the conference website on how to submit workshop proposals.

SCHEDULE

Workshop Proposals Due: Nov 15, 2006

Special Session Proposals Due: Nov 15, 2006

■ Tutorial Proposals Due: Jan 2, 2007

Regular Paper Submissions Due: Jan 2, 2007

Notification of Acceptance: March 15, 2007

Camera-Ready Papers Due: April 15, 2007

Check the conference website http://research.microsoft.com/conferences/icme07 for updates.

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